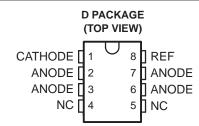
PRECISION PROGRAMMABLE REFERENCE

SLVS534B - JUNE 2004 - REVISED APRIL 2008

- **Qualified for Automotive Applications**
- 0.4% Initial Voltage Tolerance
- **0.2-** Ω Typical Output Impedance
- Fast Turnon . . . 500 ns
- Sink Current Capability . . . 1 mA to 100 mA
- Low Reference Current (REF)
- Adjustable Output Voltage . . . V_{I(ref)} to 36 V



NC - No internal connection ANODE terminals are connected internally.

description/ordering information

The TL1431 is a precision programmable reference with specified thermal stability over the automotive temperature range. The output voltage can be set to any value between $V_{|(ref)}$ (approximately 2.5 V) and 36 V with two external resistors (see Figure 16). This device has a typical output impedance of 0.2 Ω . Active output circuitry provides a very sharp turnon characteristic, making the device an excellent replacement for Zener diodes and other types of references in applications such as onboard regulation, adjustable power supplies, and switching power supplies.

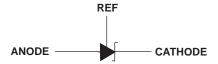
The TL1431Q is characterized for operation over the full automotive temperature range of -40°C to 125°C.

ORDERING INFORMATION†

TA	PACKAGE [‡]		ORDERABLE PART NUMBER	TOP-SIDE MARKING
-40°C to 125°C	SOIC (D) Reel of 2500		TL1431QDRQ1	1431Q1

[†] For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at http://www.ti.com.

symbol



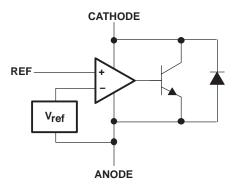


Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

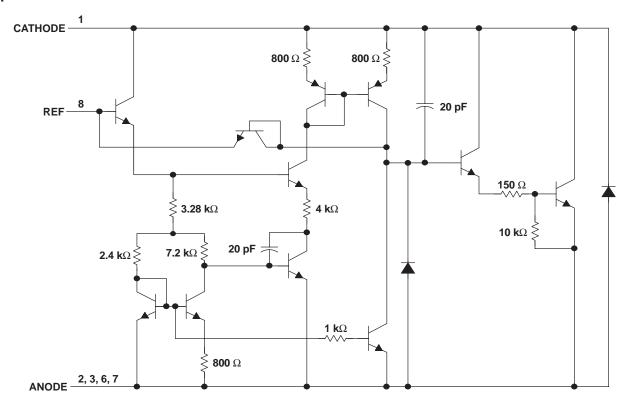


[‡] Package drawings, thermal data, and symbolization are available at http://www.ti.com/packaging.

functional block diagram



equivalent schematic†



[†] All component values are nominal.



TL1431-Q1 PRECISION PROGRAMMABLE REFERENCE

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Cathode voltage, V _{KA} (see Note 1)	37 V
Continuous cathode current range, I _{KA}	
Reference input current range, I _{I(ref)}	–50 μA to 10 mA
Package thermal impedance, θ _{JA} (see Notes 2 and 3)	97°C/W
Operating virtual junction temperature, T _J	150°C
Continuous total power dissipation	See Dissipation Rating Table
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C
Storage temperature range, T _{stq}	–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. All voltage values are with respect to ANODE, unless otherwise noted.
 - 2. Temperature and/or supply voltages must be limited to ensure that the maximum dissipation rating is not exceeded.
 - 3. The package thermal impedance is calculated in accordance with JESD 51-7.

DISSIPATION RATING TABLE

PACKAGE	ACKAGE $T_A \le 25^{\circ}C$ DERATING ABOVE		T _A = 70°C POWER RATING	T _A = 85°C POWER RATING	T _A = 125°C POWER RATING
D	1102 mW	10.3 mW/°C	638.5 mW	484 mW	72.1 mW

recommended operating conditions

		MIN	MAX	UNIT
VKA	Cathode voltage	V _{I(ref)}	36	V
IKA	Cathode current	1	100	mA
TA	Operating free-air temperature	-40	125	°C



TL1431-Q1 PRECISION PROGRAMMABLE REFERENCE

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electrical characteristics at specified free-air temperature, $I_{KA} = 10$ mA (unless otherwise noted)

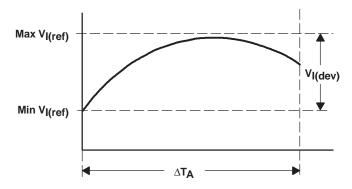
	PARAMETER	TEST CONDITIONS		T _A †	TEST CIRCUIT	MIN	TYP	MAX	UNIT
V Defended involved		Vers Vers		25°C	Fig 4	2490	2500	2510	mV
V _{I(ref)}	Reference input voltage	$V_{KA} = V_{I(ref)}$		Full range	Figure 1	2470		2530	mv
V _{I(dev)}	Deviation of reference input voltage over full temperature range‡	$V_{KA} = V_{I(ref)}$		Full range	Figure 1		17	55	mV
$\frac{\Delta V_{I(ref)}}{\Delta V_{KA}}$	Ratio of change in reference input voltage to the change in cathode voltage	ΔV _K A = 3 V to 36 V		Full range	Figure 2		-1.1	-2	mV/V
	Defended innut suggest	D4 40 kg	DO	25°C	Figure 0		1.5	2.5	
I _{I(ref)}	Reference input current	$R1 = 10 \text{ k}\Omega$	R2 = ∞	Full range	Figure 2			4	μΑ
I _{I(dev)}	Deviation of reference input current over full temperature range‡	R1 = 10 kΩ,	R2 = ∞	Full range	Figure 2		0.5	2	μА
I _{min}	Minimum cathode current for regulation	V _{KA} = V _{I(ref)}		25°C	Figure 1		0.45	1	mA
	Off state and a decomposit	V 00.V	., .	25°C	F: 0		0.18	0.5	4
loff	Off-state cathode current	$V_{KA} = 36 V,$	$V_{I(ref)} = 0$	Full range	Figure 3			2	μΑ
z _K A	Output impedance§	$V_{KA} = V_{I(ref)}$, $f \le 1$ kHz, $I_{KA} = 1$ mA to 100 mA		25°C	Figure 1		0.2	0.4	Ω

[†] Full range is -40°C to 125°C for Q-suffix devices.

$$\left|\alpha_{V_{I(ref)}}\right|\left(\frac{ppm}{^{\circ}C}\right) = \frac{\left(\frac{V_{I(dev)}}{V_{I(ref)} \text{ at } 25^{\circ}C}\right) \times 10^{6}}{\Delta T_{A}}$$

where

 $\Delta T_{\mbox{\scriptsize A}}$ is the rated operating temperature range of the device.



 $\alpha_{V_{l(ref)}}$ is positive or negative, depending on whether minimum $V_{l(ref)}$ or maximum $V_{l(ref)}$, respectively, occurs at the lower temperature.

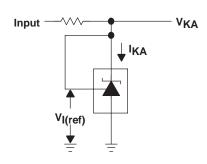
§ The output impedance is defined as: $|z_{KA}| = \frac{\Delta V_{KA}}{\Delta I_{KA}}$

When the device is operating with two external resistors (see Figure 2), the total dynamic impedance of the circuit is given by: $|z'| = \frac{\Delta V}{\Delta I}$, which is approximately equal to $|z_{KA}| \left(1 + \frac{R1}{R2}\right)$.



[‡] The deviation parameters $V_{I(deV)}$ and $I_{I(deV)}$ are defined as the differences between the maximum and minimum values obtained over the rated temperature range. The average full-range temperature coefficient of the reference input voltage $\alpha_{V_{I(ref)}}$ is defined as:

PARAMETER MEASUREMENT INFORMATION



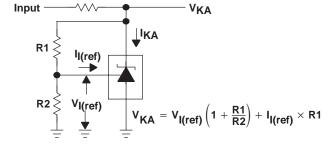


Figure 1. Test Circuit for $V_{(KA)} = V_{ref}$

Figure 2. Test Circuit for $V_{(KA)} > V_{ref}$

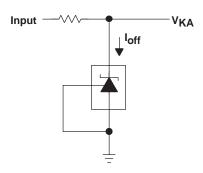


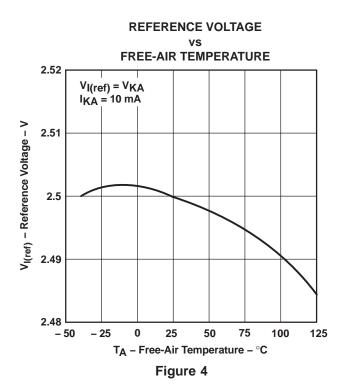
Figure 3. Test Circuit for Ioff

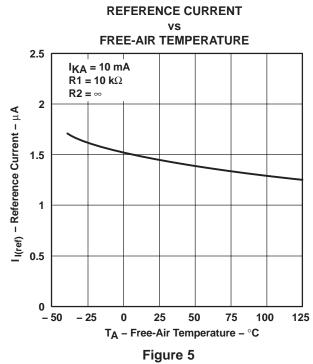
TYPICAL CHARACTERISTICS

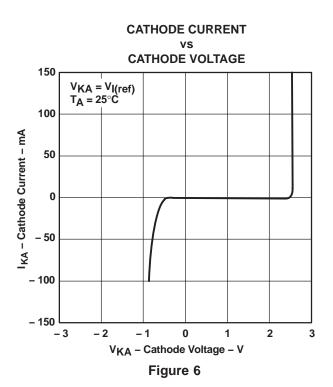
Table of Graphs

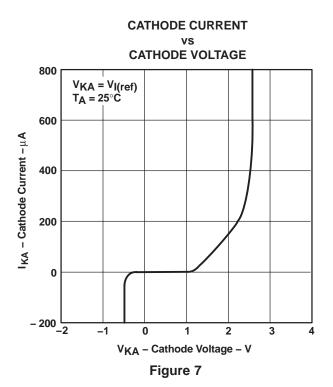
	FIGURE
Reference voltage vs Free-air temperature	4
Reference current vs Free-air temperature	5
Cathode current vs Cathode voltage	6, 7
Off-state cathode current vs Free-air temperature	8
Ratio of delta reference voltage to delta cathode voltage vs Free-air temperature	9
Equivalent input-noise voltage vs Frequency	10
Equivalent input-noise voltage over a 10-second period	11
Small-signal voltage amplification vs Frequency	12
Reference impedance vs Frequency	13
Pulse response	14
Stability boundary conditions	15

TYPICAL CHARACTERISTICS†





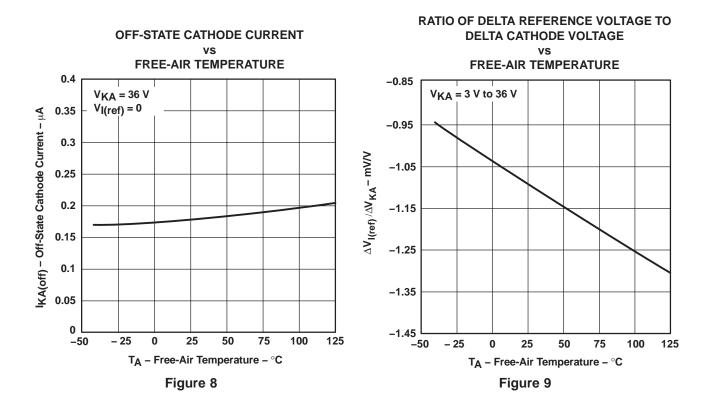




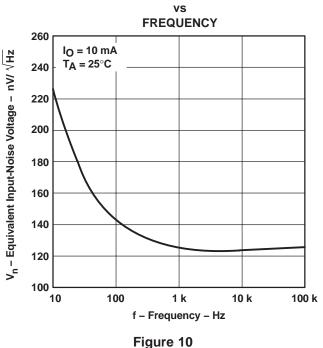
[†] Data at high and low temperatures are applicable only within the recommended operating free-air temperature ranges of the various devices.



TYPICAL CHARACTERISTICS†



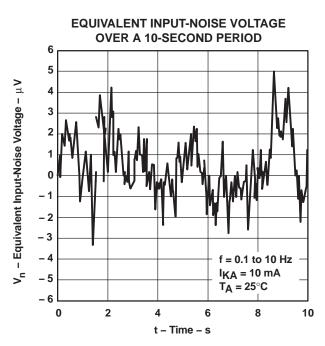
EQUIVALENT INPUT-NOISE VOLTAGE

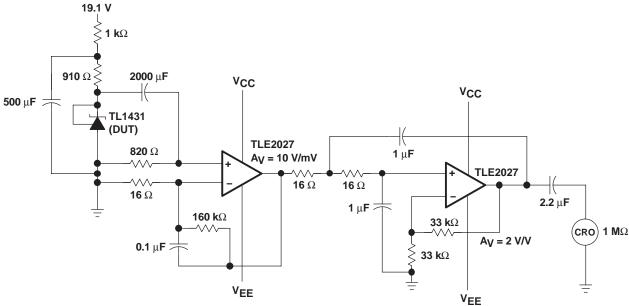


[†] Data at high and low temperatures are applicable only within the recommended operating free-air temperature ranges of the various devices.



TYPICAL CHARACTERISTICS





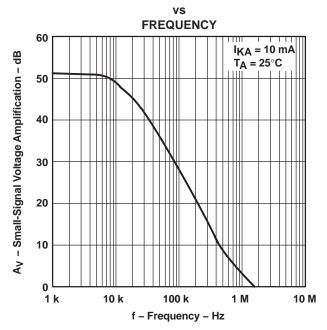
TEST CIRCUIT FOR 0.1-Hz TO 10-Hz EQUIVALENT INPUT-NOISE VOLTAGE

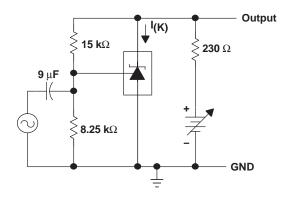
Figure 11



TYPICAL CHARACTERISTICS

SMALL-SIGNAL VOLTAGE AMPLIFICATION

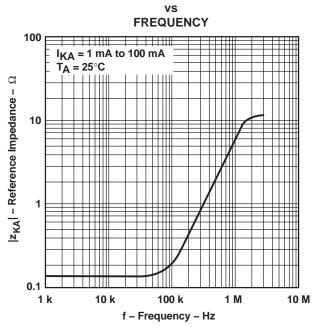


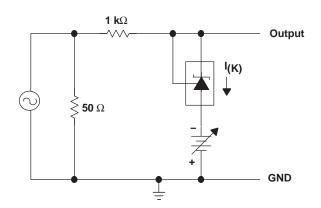


TEST CIRCUIT FOR VOLTAGE AMPLIFICATION

Figure 12

REFERENCE IMPEDANCE

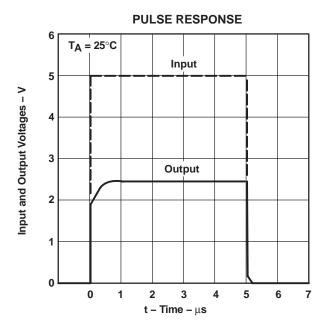




TEST CIRCUIT FOR REFERENCE IMPEDANCE

Figure 13

TYPICAL CHARACTERISTICS



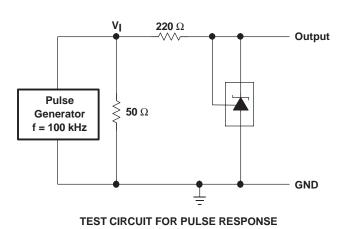
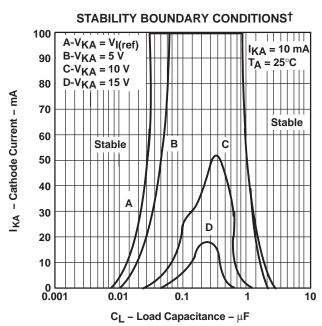
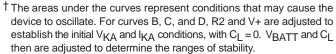
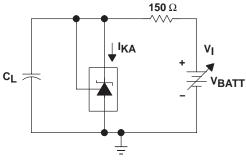


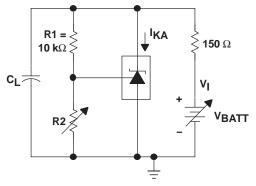
Figure 14







TEST CIRCUIT FOR CURVE A



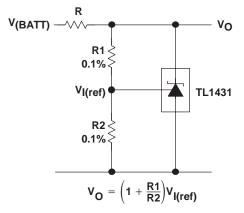
TEST CIRCUIT FOR CURVES B, C, AND D

Figure 15



Table of Application Circuits

APPLICATION	FIGURE
Shunt regulator	16
Single-supply comparator with temperature-compensated threshold	17
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Crowbar	21
Precision 5-V, 1.5-A, 0.5% regulator	22
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PWM converter with 0.5% reference	24
Voltage monitor	25
Delay timer	26
Precision current limiter	27
Precision constant-current sink	28



NOTE A: R should provide cathode current \geq 1 mA to the TL1431 at minimum $V_{(BATT)}$.

Figure 16. Shunt Regulator

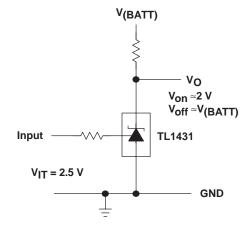
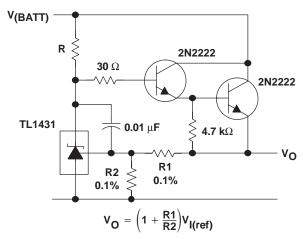


Figure 17. Single-Supply Comparator With Temperature-Compensated Threshold



NOTE A: R should provide cathode current ≥1 mA to the TL1431 at minimum V(BATT).

Figure 18. Precision High-Current Series Regulator

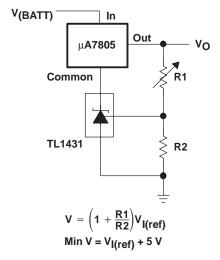


Figure 19. Output Control of a Three-Terminal Fixed Regulator

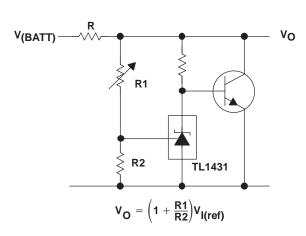
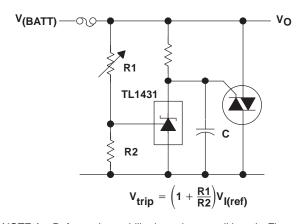
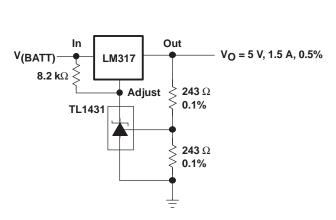


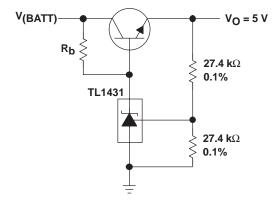
Figure 20. Higher-Current Shunt Regulator



NOTE A: Refer to the stability boundary conditions in Figure 15 to determine allowable values for C.

Figure 21. Crowbar





NOTE A: R_b should provide cathode current \geq 1 mA to the TL1431.

Figure 22. Precision 5-V, 1.5-A, 0.5% Regulator

Figure 23. 5-V Precision Regulator

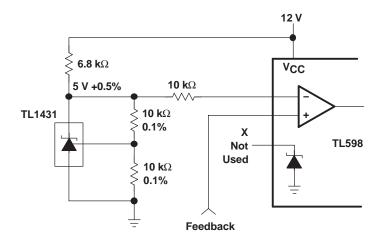
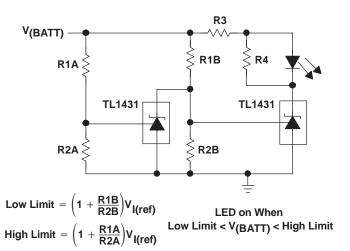


Figure 24. PWM Converter With 0.5% Reference



NOTE A: Select R3 and R4 to provide the desired LED intensity and cathode current ≥1 mA to the TL1431.

Figure 25. Voltage Monitor

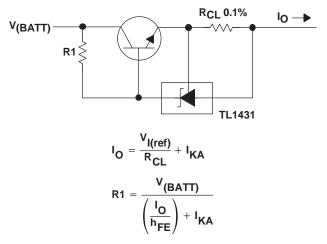


Figure 27. Precision Current Limiter

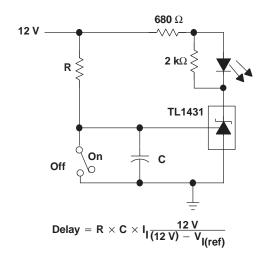


Figure 26. Delay Timer

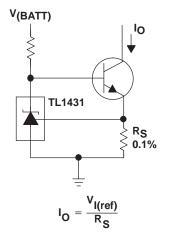


Figure 28. Precision Constant-Current Sink

www.ti.com 11-Nov-2025

PACKAGING INFORMATION

Orderable part number	Status	Material type	Package Pins	Package qty Carrier	RoHS	Lead finish/	MSL rating/	Op temp (°C)	Part marking
	(1)	(2)			(3)	Ball material	Peak reflow		(6)
						(4)	(5)		
TL1431QDRG4Q1	Active	Production	SOIC (D) 8	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	1431Q1
TL1431QDRG4Q1.A	Active	Production	SOIC (D) 8	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	1431Q1
TL1431QDRQ1	Active	Production	SOIC (D) 8	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	1431Q1
TL1431QDRQ1.A	Active	Production	SOIC (D) 8	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	1431Q1

⁽¹⁾ Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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OTHER QUALIFIED VERSIONS OF TL1431-Q1:

⁽²⁾ Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

⁽⁴⁾ Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.



PACKAGE OPTION ADDENDUM

www.ti.com 11-Nov-2025

● Catalog : TL1431

• Enhanced Product : TL1431-EP

Military: TL1431M

• Space : TL1431-SP

NOTE: Qualified Version Definitions:

• Catalog - TI's standard catalog product

• Enhanced Product - Supports Defense, Aerospace and Medical Applications

• Military - QML certified for Military and Defense Applications

• Space - Radiation tolerant, ceramic packaging and qualified for use in Space-based application



SMALL OUTLINE INTEGRATED CIRCUIT



NOTES:

- 1. Linear dimensions are in inches [millimeters]. Dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 [0.15] per side.
- 4. This dimension does not include interlead flash.
- 5. Reference JEDEC registration MS-012, variation AA.



SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



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